501821046 02/15/2012

PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Kouichi NAGAI	03/27/2009

RECEIVING PARTY DATA

Name:	FUJITSU SEMICONDUCTOR LIMITED
Street Address:	2-10-23 Shin-Yokohama Kohoku-ku
City:	Yokohama-shi, Kanagawa
State/Country:	JAPAN
Postal Code:	222-0033

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13396129

CORRESPONDENCE DATA

Fax Number: (202)822-1111
Phone: 202-822-1100

Email: PatentMail@whdapatentlaw.com

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent via US

Mail.

Correspondent Name: Westerman, Hattori, Daniels & Adrian, LL

Address Line 1: 1250 Connecticut Avenue, NW

Address Line 2: Suite-700

Address Line 4: Washington, DISTRICT OF COLUMBIA 20036-2657

ATTORNEY DOCKET NUMBER:	090966A
NAME OF SUBMITTER:	Dennis M. Hubbs

Total Attachments: 7

source=090966A_ASSIGNMENT#page1.tif source=090966A_ASSIGNMENT#page2.tif source=090966A_ASSIGNMENT#page3.tif source=090966A_ASSIGNMENT#page4.tif source=090966A_ASSIGNMENT#page5.tif source=090966A_ASSIGNMENT#page6.tif source=090966A_ASSIGNMENT#page7.tif

> PATENT REEL: 027707 FRAME: 0888

IOP \$40,00 13396129

U.S. ASSIGNMENT

IN CONSIDERATION of the sum of One Doter (\$1.00), and of other good and valuable consideration paid to the undersigned inventor(s) (hereinafter, "ASSIGNOE) by (insert Name(s) & Address(ss) of ASSIGNEE(S)) FUNTSU MICROELECTRONICS LIMITED			
7-1, Nishi-Shinjuku 2-chome, Shinjuku-ku, Tokyo163-0722 Japan			
(hereinafter, "ASSIGNEE"), the receipt of which is her ASSIGNEE the entire and exclusive right, title and into (Title of Invention)		GNOR hereby sells, assigns and transfers to	
SEMICONDUCTOR DEVICE AND N	METHOD FOR MANUFACTU	RING THE SAME	
relating to International Patent Application PCT/JP_executed on even date herewith or, if not so executed,		n for Letters Patent of the United States was	
(a) executed on	(Insert date of execution of ap	plication, (f not concurrent)	
(b) filed on	Assignee's attorney is here data, when known.	iby authorized to insert in (b) the specified	
and to said application and all Letters Patent(s) of the substitute, reissue or reexamination application based to including any extensions thereof (collectively, hereins)	hereon, for the full term or terms for which	the said Letters Patent(s) may be granted and	
The ASSIGNOR agrec(s), when requested by said which the ASSIGNEE may deem necessary, desirable including in the preparation and prosecution of said ap reexamination, or public use proceeding, and in any liti acts to include but not be limited to executing all paper sworn testimony, and obtaining and producing evidence	or expedient, for securing, maintaining and plication(s) and the issuance of said Letters gation or other legal proceeding which may rs, including separate assignments and decl	i enforcing protection for said invention, Patent(s), in any interference, reissue, arise or be declared in relation to same, such	
IN WITNESS WHEREOF, the undersigned invento	or(s) has (have) affixed his/her/their signati	ure(s).	
1) Kouichi Ragai	Kouichi NAGAI (Type Name)	March 27, 2009	
2)(Signature)	. (Type Name)	(Date)	
3) (Signature)	(Type Name)	(Dale)	
4)(Signature)	(Type Name)	(Date)	
5)(Simplified)	(Type Name)	(Date)	

PATENT REEL: 027707 FRAME: 0889



United States Patent and Trademark Office

Home | Site Index | Search | Guides | Contacts | eBusiness | eBiz alerts | News |



Electronic Patent Assignment System

Confirmation Receipt

Your assignment has been received by the USPTO. The coversheet of the assignment is displayed below:

PATENT ASSIGNMENT

Electronic Version v1.1

Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	CHANGE OF NAME

CONVEYING PARTY DATA

Name	Execution Date
FUJITSU MICROELECTRONICS LIMITED	04/01/2010

RECEIVING PARTY DATA

Name:	FUJITSU SEMICONDUCTOR LIMITED
Street Address:	2-10-23 Shin-Yokohama Kohoku-ku
City:	Yokohama-shi, Kanagawa
State/Country:	JAPAN
Postal Code:	222-0033

PROPERTY NUMBERS Total: 1043

Property Type	Number
Patent Number:	5729435
Patent Number:	5990517
Patent Number:	6104486
Patent Number:	6225677
Patent Number:	6228684

Application Number: 12499197 12500186 Application Number: 12500262 Application Number: 12500895 Application Number: 12502518 Application Number: 12503357 Application Number: 12505639 Application Number: 12508642 Application Number: 12508642 Application Number: 12508642 Application Number: 12533472 Application Number: 12533472 Application Number: 12533816 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 1253923 Application Number: 1253923 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12543794 Application Number: 12544810 Application Number: 12544810 Application Number: 1254466 Application Number: 1254027 Application Number: 1254027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548811 Application Number: 12548911 Application Number: 12553388 Application Number: 12557596 Application Number: 12557966 Application Number: 125		
Application Number: 1250262 Application Number: 12502518 Application Number: 12503357 Application Number: 12505639 Application Number: 12508642 Application Number: 12508642 Application Number: 12533472 Application Number: 12533472 Application Number: 12538410 Application Number: 12538410 Application Number: 12539017 Application Number: 1253900 Application Number: 12539200 Application Number: 12539723 Application Number: 12541279 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12543794 Application Number: 12543810 Application Number: 12543810 Application Number: 12543810 Application Number: 12543810 Application Number: 125438410 Application Number: 1254384810 Application Number: 12543848 Application Number: 12548027 Application Number: 12548027 Application Number: 12548838 Application Number: 12548838 Application Number: 12548838 Application Number: 12543838 Application Number: 12553388 Application Number: 12557159	Application Number:	12499197
Application Number: 12502518 Application Number: 12503357 Application Number: 12505639 Application Number: 12508642 Application Number: 12508642 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 1253900 Application Number: 12539200 Application Number: 1253923 Application Number: 1253923 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12542244 Application Number: 1254399 Application Number: 12544810 Application Number: 12545469 Application Number: 12545469 Application Number: 12548098 Application Number: 12548098 Application Number: 12548838 Application Number: 12548811 Application Number: 12548811 Application Number: 12553388	Application Number:	12500186
Application Number: 12502518 Application Number: 12508357 Application Number: 12508357 Application Number: 12508140 Application Number: 12508642 Application Number: 12510608 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12538410 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 12539723 Application Number: 12541279 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12544810 Application Number: 12548027 Application Number: 12548027 Application Number: 12548027 Application Number: 1254808 Application Number: 1254881 Application Number: 1254891 Application Number: 1254891 Application Number: 12550727 Application Number: 12553388 Application Number: 12553159 Application Number: 12553388 Application Number: 12553388 Application Number: 12553159 Application Number: 12553159 Application Number: 12553388 Application Number: 12553159 Application Number: 12553388 Application Number: 12553159 Application Number: 12553388 Applica	Application Number:	12500262
Application Number: 12503357 Application Number: 12508649 Application Number: 12508642 Application Number: 12510608 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 12539723 Application Number: 12539723 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12544810 Application Number: 12544809 Application Number: 12548027 Application Number: 12548027 Application Number: 12548027 Application Number: 1254808 Application Number: 12548838 Application Number: 12548811 Application Number: 12548911 Application Number: 12553388	Application Number:	12500895
Application Number: 12508639 Application Number: 12508642 Application Number: 12508642 Application Number: 12533472 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 12539723 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545466 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548911 Application Number: 12548911 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12502518
Application Number: 12508140 Application Number: 12508642 Application Number: 12510608 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 12539723 Application Number: 12541279 Application Number: 12541279 Application Number: 12542243 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548911 Application Number: 12548911 Application Number: 12553388 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12503357
Application Number: 12510608 Application Number: 12533472 Application Number: 12533472 Application Number: 12538216 Application Number: 12538216 Application Number: 12539017 Application Number: 12539200 Application Number: 12539723 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12548027 Application Number: 12548027 Application Number: 1254808 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12553388	Application Number:	12505639
Application Number: 12533472 Application Number: 12538216 Application Number: 12538410 Application Number: 12539017 Application Number: 12539200 Application Number: 12539200 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 1254369 Application Number: 12544810 Application Number: 12545469 Application Number: 12545469 Application Number: 12548027 Application Number: 12548027 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12553388 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12508140
Application Number: 12533472 Application Number: 12538216 Application Number: 12538410 Application Number: 12539017 Application Number: 12539200 Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12543794 Application Number: 12544810 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548027 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12553388 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12508642
Application Number: 12538216 Application Number: 12538410 Application Number: 12539017 Application Number: 12539200 Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12548027 Application Number: 12548027 Application Number: 12548838 Application Number: 12548838 Application Number: 12548851 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12510608
Application Number: 12538410 Application Number: 12539017 Application Number: 12539200 Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12542439 Application Number: 12542244 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12548027 Application Number: 12548027 Application Number: 12548838 Application Number: 12548831 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12533472
Application Number: 12539017 Application Number: 12539200 Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 1254808 Application Number: 12548838 Application Number: 12548851 Application Number: 12553388	Application Number:	12538216
Application Number: 12539200 Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12538410
Application Number: 12539694 Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548831 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12539017
Application Number: 12539723 Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548838 Application Number: 12548831 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12539200
Application Number: 12541279 Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 125454810 Application Number: 12545456 Application Number: 12545469 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12539694
Application Number: 12541639 Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548838 Application Number: 12548831 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12553388 Application Number: 12557159	Application Number:	12539723
Application Number: 12542243 Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 1254838 Application Number: 12548838 Application Number: 12548811 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12541279
Application Number: 12542274 Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12541639
Application Number: 12543794 Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12542243
Application Number: 12544810 Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12542274
Application Number: 12545456 Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12543794
Application Number: 12545469 Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12544810
Application Number: 12547126 Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12545456
Application Number: 12548027 Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12545469
Application Number: 12548098 Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12547126
Application Number: 12548838 Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12548027
Application Number: 12548851 Application Number: 12548911 Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12548098
Application Number:12548911Application Number:12550727Application Number:12553388Application Number:12557159	Application Number:	12548838
Application Number: 12550727 Application Number: 12553388 Application Number: 12557159	Application Number:	12548851
Application Number: 12553388 Application Number: 12557159	Application Number:	12548911
Application Number: 12557159	Application Number:	12550727
	Application Number:	12553388
Application Number: 12557986	Application Number:	12557159
	Application Number:	12557986
Application Number: 12561719	Application Number:	12561719



Address Line 1: 1250 Connecticut Avenue, NW Address Line 2: Suite-700 Address Line 4: Washington, DISTRICT OF COLUMBIA 20036-2657	
ATTORNEY DOCKET 100607 NUMBER:	
NAME OF SUBMITTER:	Stephen G. Adrian
Signature:	/Stephen G. Adrian/
Date:	07/09/2010
Total Attachments: 15 source=100607_Commerical_Register#page1.tif source=100607_Commerical_Register#page2.tif source=100607_Commerical_Register#page3.tif source=100607_Commerical_Register#page4.tif source=100607_Commerical_Register#page5.tif source=100607_Commerical_Register#page6.tif source=100607_Commerical_Register#page7.tif source=100607_Commerical_Register#page8.tif source=100607_Commerical_Register#page9.tif source=100607_Commerical_Register#page10.tif source=100607_Commerical_Register#page11.tif source=100607_Commerical_Register#page12.tif source=100607_Commerical_Register#page13.tif source=100607_Commerical_Register#page14.tif source=100607_Commerical_Register#page15.tif	
RECEIPT INFORMATION	
EPAS ID: PAT125190 Receipt Date: 07/09/2010 Fee Amount: \$41720	

Return to home page Start another assignment from the same template

| .HOME | INDEX| SEARCH | @BUSINESS | CONTACT US | PRIVACY STATEMENT



United States Patent and Trademark Office

Under Secretary of Commerce for Intellectual Property and Director of the United States Patent and Trademark Office



JULY 09, 2010

USPTO

501228198A

WESTERMAN, HATTORI, DANIELS & ADRIAN, LL 1250 CONNECTICUT AVENUE, NW SUITE-700 WASHINGTON, DC 20036-2657

UNITED STATES PATENT AND TRADEMARK OFFICE NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT DIVISION OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE MICROFILM COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE EMPLOYEE WHOSE NAME APPEARS ON THIS NOTICE AT 571-272-3350. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, MAIL STOP: ASSIGNMENT SERVICES BRANCH, P.O. BOX 1450, ALEXANDRIA, VA 22313.

RECORDATION DATE: 07/09/2010 REEL/FRAME: 024651/0744 NUMBER OF PAGES: 46

BRIEF: CHANGE OF NAME (SEE DOCUMENT FOR DETAILS).

DOCKET NUMBER: 100607

ASSIGNOR:

FUJITSU MICROELECTRONICS LIMITED DOC DATE: 04/01/2010

ASSIGNEE:

FUJITSU SEMICONDUCTOR LIMITED 2-10-23 SHIN-YOKOHAMA KOHOKU-KU YOKOHAMA-SHI, KANAGAWA, JAPAN

222-0033

SERIAL NUMBER: 10336716 FILING DATE: 01/06/2003

PATENT NUMBER: ISSUE DATE:

TITLE: LEAD FRAME AND MANUFACTURING METHOD THEREOF AND A SEMICONDUCTOR

DEVICE

P.O. Box 1450, Alexandria, Virginia 22313-1450 - www.uspto.gov

USPTO 7/9/2010 6:52:41 PM PAGE 31/120 Fax Server

TO: WESTERMAN, HATTORI, DANIELS & ADRIAN, LL COMPANY: 1250 CONNECTICUT AVENUE,

024651/0744 PAGE 30

SERIAL NUMBER: 12539200 FILING DATE: 08/11/2009

PATENT NUMBER: ISSUE DATE: TITLE: MANUFACTURING METHOD OF SEMICONDUCTOR DEVICE

SERIAL NUMBER: 12539694 FILING DATE: 08/12/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

SERIAL NUMBER: 12539723 FILING DATE: 08/12/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

SERIAL NUMBER: 12541279 FILING DATE: 08/14/2009

PATENT NUMBER: ISSUE DATE:

TITLE: METHOD OF MANUFACTURING A SEMICONDUCTOR DEVICE INCLUDING

EPITAXIALLY GROWING SEMICONDUCTOR EPITAXIAL LAYERS ON A SURFACE OF

SEMICONDUCTOR SUBSTRATE

SERIAL NUMBER: 12541639 FILING DATE: 08/14/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING THE SAME

SERIAL NUMBER: 12542243 FILING DATE: 08/17/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

SERIAL NUMBER: 12542274 FILING DATE: 08/17/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

SERIAL NUMBER: 12543794 FILING DATE: 08/19/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND MANUFACTURING METHOD OF THE SAME

SERIAL NUMBER: 12544810 FILING DATE: 08/20/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE FABRICATION METHOD

SERIAL NUMBER: 12545456 FILING DATE: 08/21/2009

PATENT NUMBER: ISSUE DATE:

TITLE: METHOD AND SYSTEM FOR MANUFACTURING SEMICONDUCTOR DEVICE HAVING

LESS VARIATION IN ELECTRICAL CHARACTERISTICS

SERIAL NUMBER: 12545469 FILING DATE: 08/21/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD FOR MANUFACTURING THE SAME

SERIAL NUMBER: 12547126 FILING DATE: 08/25/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SEMICONDUCTOR DEVICE AND METHOD OF MANUFACTURING SAME

SERIAL NUMBER: 12548027 FILING DATE: 08/26/2009

PATENT NUMBER: ISSUE DATE:

TITLE: SURFACE PROFILE SENSOR AND METHOD FOR MANUFACTURING THE SAME

12/545,469 SEMICONDUCTOR DEVICE

090966

02-13-

2012::09:52:33

Patent Assignment Abstract of Title

Total Assignments: 2

Application #: 12545469

Filing Dt: 08/21/2009

Patent #: NONE

Publication #: US20100019348

Issue Dt:

Pub Dt: 01/28/2010

PCT #: NONE

Inventor: Kouichi Nagai

TITIE: SEMICONDUCTOR DEVICE

Assignment: 1

Reel/Frame: 023362 / 0988

Received: 10/13/2009

Recorded: 10/13/2009

Mailed: 10/13/2009

Pages: 2

Conveyance: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

Assignor: NAGAI, KOUICHI

Exec Dt: 03/27/2009

Assignee: FUJITSU MICROELECTRONICS LIMITED

7-1, NISHI-SHIN)UKU 2-CHOME, SHINJUKU-KU

TOKYO, JAPAN 163-0722

Correspondent: WESTERMAN, HATTORI, DANIELS & ADRIAN, LL

1250 CONNECTICUT AVENUE, NW

SUITE-700

WASHINGTON, DC 20036-2657

Assignment: 2

Reel/Frame: 024651 / 0744

Received: 07/09/2010

Recorded: 07/09/2010

Malled: 07/09/2010

Exec Dt: 04/01/2010

Pages: 46

Conveyance: CHANGE OF NAME (SEE DOCUMENT FOR DETAILS).

Assignor: FUJITSU MICROELECTRONICS LIMITED

Assignee: FUJITSU SEMICONDUCTOR LIMITED 2-10-23 SHIN-YOKOHAMA KOHOKU-KU

YOKOHAMA-SHI, KANAGAWA, JAPAN 222-0033

Correspondent: WESTERMAN, HATTORI, DANIELS & ADRIAN, LL

1250 CONNECTICUT AVENUE, NW

SUITE-700

WASHINGTON, DC 20036-2657

Search Results as of: 02/13/2012 09:52:25 AM

Disclaimer:

Assignment Information on the assignment database reflects assignment documents that have been actually recorded. If the assignment for a patent was not recorded, the name of the assignee on the patent application publication or patent may be different.

If you have any comments or questions concerning the data displayed, contact OPR / Assignments at 571-272-3350

Close Window

PATENT 02/13/2012 REEL: 027707 FRAME: 0895